



6-20414

Tamperproofing Adhesive

APPLICATIONS

- Tamperproofing

FEATURES

- UV/Visible Light Cure
- High Durometer/Hardness
- Tack-Free Surface
- Excellent Adhesion to a Variety of Substrates
- Good Depth of Cure

RECOMMENDED SUBSTRATES

- ABS
- CAP
- PC
- PETG
- PMMA
- PPO
- PSU

6-20414 structural adhesive cures exceptionally fast and deep and is designed for the tamper proofing of set screws in electrical relays. The product has excellent adhesion to metal, glass, ceramic, thermoset plastics, and phenolics. Dymax adhesives contain no nonreactive solvents and cure upon exposure to light. Their ability to cure in seconds enables faster processing, greater output, and lower processing costs. When cured with Dymax light-curing spot lamps, focused-beam lamps, or flood lamps, they deliver optimum speed and performance for assembly. Dymax lamps offer the optimum balance of UV and visible light for the fastest, deepest cures. This product is in full compliance with RoHS directives 2015/863/EU.

UNCURED PROPERTIES *		
Property	Value	Test Method
Solvent Content	None - 100% reactive solids	N/A
Chemical Class	Urethane Acrylate	N/A
Appearance	Amber Liquid	N/A
Soluble in	Alcohols/Chlorinated Solvents/Ketones	N/A
Viscosity, cP	13,000 (nominal)	ASTM D1084
Shelf Life at Recommended Conditions from Date of Manufacture	18 months	N/A

OTHER CURED PROPERTIES †		
Property	Value	Test Method
Refractive Index (20°C)	1.50	ASTM D542
Boiling Water Absorption, % (2 h)	4.6	ASTM D570
Water Absorption, % (25°C, 24 h)	1.5	ASTM D570
Linear Shrinkage, %	0.43	ASTM 2566
Dielectric Strength (V/mil)	500	ASTM D-1304
Glass Transition Tg, °C	125	ASTM D5418
CTE α 1, $\mu\text{m}/\text{m}/^\circ\text{C}$	78	ASTM E831
CTE α 2, $\mu\text{m}/\text{m}/^\circ\text{C}$	202	ASTM E831

CURED MECHANICAL PROPERTIES ‡		
Property	Value	Test Method
Durometer Hardness (light-cure only)	D85	ASTM D2240
Tensile at Break, MPa [psi]	50 [7,250]	ASTM D638
Elongation at Break, %	10	ASTM D638
Modulus of Elasticity, MPa [psi]	15.2 [2,200]	ASTM D638

ADHESION	
Substrate	Recommendation
ABS (acrylonitrile-butadiene-styrene)	✓
CAP (cellulose acetate propionate)	✓
PC (polycarbonate)	✓
PETG (ethylene terephthalate) glycol	✓
PSU (polysulfone)	✓
FR-4 Board	✓
PMMA (methyl methacrylate)	✓
PPO (phenylene chloride)	✓
PVC poly(vinyl chloride)	✓
SAN (styrene-acrylonitrile)	✓

✓ Recommended ◦ Limited Applications
 st Requires Surface Treatment (e.g. plasma, corona treatment, etc.)

* Not Specifications

N/A Not Applicable

‡ Measured after UV cure followed by 15 days at 25°C/50% RH

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CURING GUIDELINES

Fixture time is defined as the time to develop a shear strength of 0.1 N/mm² [10 psi] between glass slides. Actual cure time typically is 3-to-5 times fixture time.

Dymax Curing System (Intensity)	Fixture Time or Belt Speed ^A
2000-ECE (50 mW/cm ²) ^B	1s
5000-ECE (200 mW/cm ²) ^B	1s
BlueWave® AX-550 RediCure® 365 nm (450 mW/cm ²) ^C	0.2s
BlueWave® AX-550 PrimeCure® 385 nm (850 mW/cm ²) ^C	0.2s
BlueWave® AX-550 VisiCure® 405 nm (950 mW/cm ²) ^C	0.2s
BlueWave® MX-150 RediCure® 365 nm (15 W/cm ²) ^C	0.2s
BlueWave® MX-150 PrimeCure® 385 nm (15 W/cm ²) ^C	0.2s
BlueWave® MX-150 VisiCure® 405 nm (15 W/cm ²) ^C	0.2s
UVCS Conveyor with Fusion F300S (2.5 W/cm ²) ^D	27.3 ft/min

^A Fixture times/belt speeds are typical for curing thin films through 100% UV and light-transmitting substrates. Light-obstructing substrates may require longer cure times.

^B Intensity was measured over the UVA range (320-395 nm) using a Dymax ACCU-CAL™ 50 Radiometer.

^C Intensity was measured over the UVA/Visible range (350-450 nm) using a Dymax ACCU-CAL™ 50-LED Radiometer.

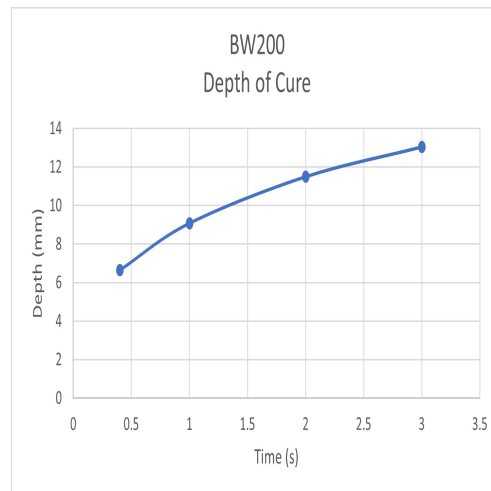
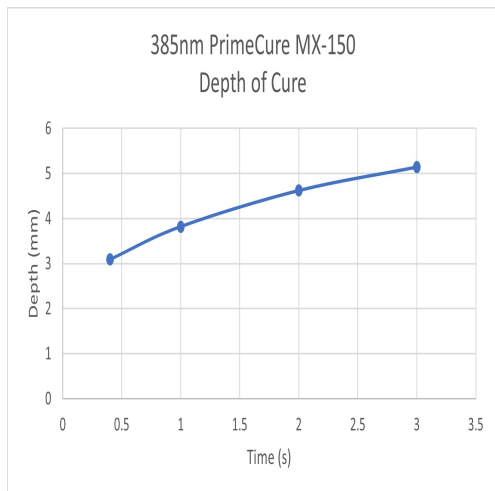
^D At 53 mm [2.1 in] focal distance. Maximum speed of conveyor is 8.2 m/min [27 ft/min]. Intensity was measured over the UVA range (320-395 nm) using the Dymax ACCU-CAL™ 150 Radiometer.

Full cure is best determined empirically by curing at different times and intensities, and measuring the corresponding change in cured properties such as tackiness, adhesion, hardness, etc. Full cure is defined as the point at which more light exposure no longer improves cured properties.

Dymax recommends that customers employ a safety factor by curing longer and/or at higher intensities than required for full cure. Although Dymax Application Engineering can provide technical support and assist with process development, each customer must ultimately determine and qualify the appropriate curing parameters required for their unique application.

DEPTH OF CURE

The graph below shows the increase in depth of cure as a function of light curing exposure time. A 9.5 mm [0.37 in] diameter specimen was cured in a polypropylene mold and cooled to room temperature. It was then released from the mold and the cure depth was measured. No time was given to allow for the secondary moisture cure.





OPTIMIZING PERFORMANCE AND HANDLING

1. This product cures with exposure to UV and visible light. Exposure to ambient and artificial light should be kept to a minimum before curing. Dispensing components including needles and fluid lines should be 100% light blocking, not just UV blocking.
2. All bond surfaces should be clean and free from grease, mold release, or other contaminants prior to dispensing the adhesive.
3. Cure speed is dependent upon many variables, including lamp intensity, distance from the light source, required depth of cure, bond gap, and percent light transmission of the substrate.
4. Oxygen in the atmosphere may inhibit surface cure. Surfaces exposed to air may require high-intensity UV light to produce a dry surface cure. Flooding the bond area with an inert gas, such as nitrogen, can also reduce the effects of oxygen inhibition.
5. Parts should be allowed to cool after cure before testing and subjecting to any loads.
6. In rare cases, stress cracking may occur in assembled parts. Three options may be explored to eliminate this problem. One option is to heat anneal the parts to remove molded-in stresses. A second option is to open the gap between mating parts to reduce stress caused by an interference fit. The third option is to minimize the amount of time the liquid adhesive remains in contact with the substrate(s) prior to curing.
7. Light curing generally produces some heat. If necessary, cooling fans can be placed in the curing area to reduce the heating effect on components.
8. At the point of curing, an air exhaust system is recommended to dissipate any heat and vapors formed during the curing process

DISPENSING SUPPORT

The Dymax Application Engineering team is ready to discuss your application requirements to provide the most appropriate dispensing and/or spraying solution. Visit our current dispensing equipment portfolio [here](#) or consult our [global contact](#) phone numbers and online chat feature (available in North America only) during normal business hours for instant support.

STORAGE AND SHELF LIFE

Store the material in a low-humidity, cool, and dark place when not in use. This product may polymerize upon prolonged exposure to ambient and artificial light as well as moisture. The material shelf life is noted on page 1 of this document when stored between 10°C (50°F) and 32°C (90°F) in the original, unopened container. Resealing large containers under dry inert gas, such as nitrogen, can help maintain the shelf life. Smaller syringes and cartridges should be kept in moisture barrier bags with desiccant when not in use.

CLEAN UP

Uncured Dymax dual-cure materials may be removed from dispensing components and parts with non-alcoholic solvents. Alcoholic solvents (such as IPA or ethanol) that contain moisture activate the curing process. Therefore, it is recommended that non-alcohols such as Butyl Acetate, Acetone, or MEK be used to clean up uncured material and purge wetted dispensing lines. Cured material will be impervious to many solvents and difficult to remove. Cleanup of cured material may require mechanical methods such as ultrasonic bath, water jet, vacuum tweezers, air knife, and/or warming to aid in the removal.



GENERAL INFORMATION

This product is intended for industrial use only. Keep out of the reach of children. Avoid breathing vapors. Avoid contact with skin, eyes, and clothing. Wear impervious gloves. Repeated or continuous skin contact with uncured material may cause irritation. Remove material from skin with soap and water. Never use organic solvents to remove material from skin and eyes. For more information on the safe handling of this material, please refer to the Safety Data Sheet before use.

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CONTACT DYMAX

www.dymax.com

Americas

USA | +1.860.482.1010 | info@dymax.com

Europe

Germany | +49 611.962.7900 | info_de@dymax.com

Ireland | +353 21.237.3016 | info_ie@dymax.com

Asia

Singapore | +65.67522887 | info_ap@dymax.com

Shenzhen | +86.755.83485759 | dymaxasia@dymax.com

Hong Kong | +852.2460.7038 | dymaxasia@dymax.com

Korea | +82.31.608.3434 | info_kr@dymax.com